

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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Application of :  
 Toshio KODAMA et al. :  
 Serial No. 10/520,982 :  
 Filed: January 11, 2005 :  
 For: ION BEAM APPARATUS, AND :  
       ION BEAM PROCESSING :  
       METHOD, AND HOLDER :  
       MEMBER : Docket No. S004-5433 (PCT)

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MS PCT  
 COMMISSIONER FOR PATENTS  
 P.O. Box 1450  
 Alexandria, VA 22313-1450

SUPPLEMENTAL TRANSMITTAL OF DECLARATION

S I R:

On January 11, 2005, new patent application papers were filed at the United States Patent and Trademark Office in respect of the above-identified application. The application was filed without a declaration and to remedy this informality, applicants submit herewith a declaration duly signed by the inventors. As the attorneys of record have not received the Notification of Missing Requirements Under 35 U.S.C. 371 in the United States Designated/Elected Office (DO/EO/US) ("Notification"), they are unable to furnish the same herewith.

MAILING CERTIFICATE ON PAGE 2

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130.00 OP

A check in the amount \$130.00 is enclosed herewith to cover the surcharge for the late filing of the declaration.

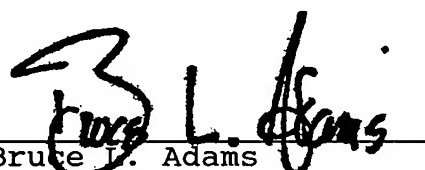
Should the check prove insufficient for any reason, authorization is hereby given to charge any such deficiency to our Deposit Account No. 01-0268.

It is respectfully requested that the processing of the application be completed, and that the filing receipt be issued in due course.

Respectfully submitted,

ADAMS & WILKS  
Attorneys for Applicants

By:

  
Bruce L. Adams  
Reg. No. 25,386

50 Broadway  
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New York, NY 10004  
(212) 809-3700

MAILING CERTIFICATE

I hereby certify that this correspondence is being deposited with the United States Postal Service as first-class mail in an envelope addressed to: MS PCT, COMMISSIONER FOR PATENTS, P.O. Box 1450, Alexandria, VA 22313-1450, on the date indicated below.

Debra Buonincontri

Name



Signature

March 9, 2005

Date

# DECLARATION FOR PATENT APPLICATION

As a below named inventor, I hereby declare that my residence, post office address and citizenship are as stated below next to my name; I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled ION BEAM APPARATUS;  
AND ION BEAM PROCESSING METHOD, AND HOLDER MEMBER, as described and claimed in

PCT/JP2003/008691 filed July 9, 2003

the specification of which (check one); ☐ is attached hereto: ☒ was filed on JANUARY 11, 2005 as Application Serial No.            /            and was amended on (or amended through)            (if applicable). I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment(s) referred to above. I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56(a). I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate having a filing date before that of the application on which priority is claimed.

## Prior Foreign Application(s)

(Number)	(Country)	(Day/Month/Year Filed)	Priority Claimed	
2002-204028	Japan	12 07 2002	<input checked="" type="checkbox"/> Yes	<input type="checkbox"/> No
			<input type="checkbox"/> Yes	<input type="checkbox"/> No
			<input type="checkbox"/> Yes	<input type="checkbox"/> No
			<input type="checkbox"/> Yes	<input type="checkbox"/> No
			<input type="checkbox"/> Yes	<input type="checkbox"/> No
			<input type="checkbox"/> Yes	<input type="checkbox"/> No

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, §1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Application Serial No.)	(Filing Date)	(Status - Patented, Pending or Abandoned)

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

## POWER OF ATTORNEY

I (we) hereby appoint Bruce L. Adams, Registration No. 25,386, Van C. Wilks, Registration No. 25,027 and Franco S. De Liguori, Registration No. 36,497 whose post office address is: Adams & Wilks, 50 Broadway, 31st Floor, New York, New York 10004, as my (our) attorneys with full power of substitution and revocation, to prosecute this application, and to transact all business in the United States Patent and Trademark Office connected therewith.

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Date <b>17th/Feb/2005</b>	Signature <i>Toshio Kodama</i>

☒ See second page for additional joint inventors.

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Date ✓ February 25, 2005	Signature ✓ <i>Masakatsu Hasuda</i>

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Date ✓ February 25, 2005	Signature ✓ <i>Yasuyuki Takagi</i>

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